**Text used in PCB**

**Files:**

\*.GTO - Top Overlay

\*.GTP - Top Paste

\*.GTS - Top Solder

\*.GTL - L1 (Positive)

\*.GBL - L2 (Positive)

\*.GBS - Bottom Soldering

\*.GBO - Bottom Overlay

\*.GM2 - Mechanical Drawing

\*.GM3 - Manufacturing Notes

\*.GM4 - License

\*.GM28 - Board Outline

**Board info**

Minimum Track: 200um

Minimum Gap: 200um

Minimum Through Hole VIA: 0.6mm (pad) / 0.3mm (drill). Drilling: L1-L2

1. FINISHED PANEL THICKNESS IS NOT CRITICAL: TO BE APPROXIMATELY 1.6mm

2. BOARD FINISH: IMMERSION Au/ELECTROLESS Ni: 0.05-0.12 um GOLD; 3-6um NICKEL

3. SOLDER RESIST: APPLY TO BOTH SIDES COLOUR - RED

4. COMPONENT IDENT: COLOUR TO BE WHITE

5. PANELIZE THE BOARD (4PCS PER PANEL). PLACE FIDUCIALS ON THE PANEL STRIPS AS FOLLOWS:

- FIDUCIAL DIAMETER 1-1.5MM, SOLDER MASK OPENING AT LEAST 1MM GREATER THAN FIDUAL

-MINIMUM 4MM DISTANCE FROM THE PANEL EDGE

-3 FIDUALS SHOULD LIE ON TWO LINES THAT INTERSECT AT A RIGHT ANGLE

-PLACE ONE FIDUCIAL INTO EACH PANEL CORNER (FOUR ON THE TOP LAYER)